

### Description

The 60N10 uses advanced technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

### General Features

$V_{DS} = 100V$   $I_D = 60A$

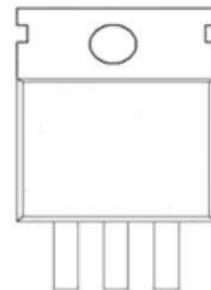
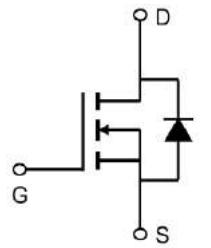
$R_{DS(ON)} < 12m\Omega$  @  $V_{GS}=10V$  (Type: 9.0m $\Omega$ )

### Application

Isolated DC

Motor control

Synchronous-rectification



### Absolute Maximum Ratings ( $T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain source voltage	100	V
$V_{GS}$	Gate source voltage	$\pm 20$	V
$I_D$	Continuous drain current, $T_c=25^\circ C$	60	A
$I_{DM}$	Pulsed drain current, $T_c=25^\circ C$	180	A
$P_D$	Power dissipation, $T_c=25^\circ C$	107	W
$E_{AS}$	Single pulsed avalanche energy <sup>4)</sup>	183.8	mJ
$T_{stg}, T_j$	Operation and storage temperature	-55 to 150	°C
$R_{\theta JC}$	Thermal resistance, junction-case	1.17	°C/W
$R_{\theta JA}$	Thermal resistance, junction-ambient <sup>4)</sup>	62	°C/W

**100V N-Channel Enhancement Mode MOSFET**
**Electrical Characteristics ( $T_c=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
BVDSS	Drain-source breakdown voltage	$V_{GS}=0 \text{ V}, I_D=250 \mu\text{A}$	100	111		V
VGS(th)	Gate threshold voltage	$V_{DS}=V_{GS}, I_D=250 \mu\text{A}$	1.2	1.8	2.5	V
RDS(ON)	Drain-source on-state resistance	$V_{GS}=10 \text{ V}, I_D=20 \text{ A}$		9.0	12.0	$\text{m}\Omega$
RDS(ON)	Drain-source on-state resistance	$V_{GS}=4.5 \text{ V}, I_D=12 \text{ A}$		12	14.0	$\text{m}\Omega$
IGSS	Gate-source leakage current	$V_{GS}=\pm 20 \text{ V}$			$\pm 100$	nA
IDSS	Drain-source leakage current	$V_{DS}=100 \text{ V}, V_{GS}=0 \text{ V}$			1	uA
$R_G$	Gate resistance	f= 1 MHz, Open drain		5.5		$\Omega$
Ciss	Input capacitance	$V_{GS}=0 \text{ V}, V_{DS}=50 \text{ V}, f=100 \text{ kHz}$		1998.1		pF
Coss	Output capacitance			321.7		pF
Crss	Reverse transfer capacitance			7.1		pF
td(on)	Turn-on delay time		$V_{GS}=10 \text{ V},$	22.1		ns
$t_r$	Rise time	$V_{DS}=50 \text{ V},$		5.2		ns
td(off)	Turn-off delay time	$R_G=2 \Omega,$		44		ns
$t_f$	Fall time	$I_D=25 \text{ A}, V_{DS}=50 \text{ V}, V_{GS}=10 \text{ V}$		8.4		ns
$Q_g$	Total gate charge			28.9		nC
$Q_{gs}$	Gate-source charge			6		nC
$Q_{gd}$	Gate-drain charge			6.8		nC
Vplateau	Gate plateau voltage			3.7		V
$I_s$	Diode forward current			60	A	
ISP	Pulsed source current	$V_{GS}<V_{th}$		180		
VSD	Diode forward voltage	$I_s=20 \text{ A}, V_{GS}=0 \text{ V}$		1.3		V
trr	Reverse recovery time		102.9		ns	
$Q_{rr}$	Reverse recovery charge	$I_s=25 \text{ A}, di/dt=100 \text{ A}/\mu\text{s}$		379		nC
Irmm	Peak reverse recovery current			6.4		A

**Note :**

- 1、The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.
- 2、The data tested by pulsed , pulse width  $\leq 300\mu\text{s}$  , duty cycle  $\leq 2\%$
- 3、The EAS data shows Max. rating . The test condition is  $VDD=30\text{V}, VGS=10\text{V}, L=0.3\text{mH}$ , starting  $T_j=25^\circ\text{C}$
- 4、The power dissipation is limited by  $150^\circ\text{C}$  junction temperature
- 5、The data is theoretically the same as  $I_D$  and  $I_{DM}$  , in real applications , should be limited by total power dissipation

### Typical Characteristics

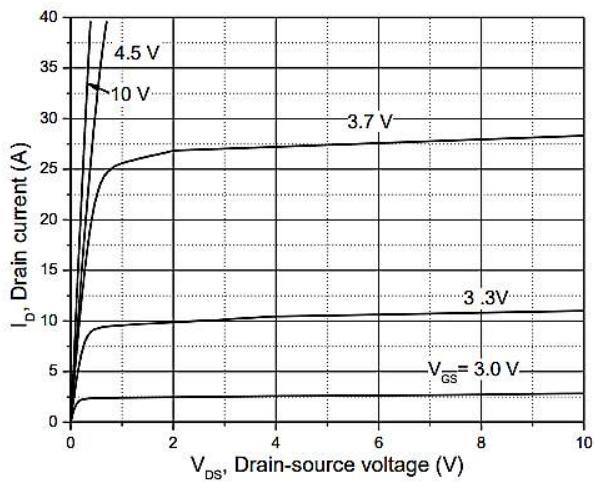


Figure 1. Typ. output characteristics

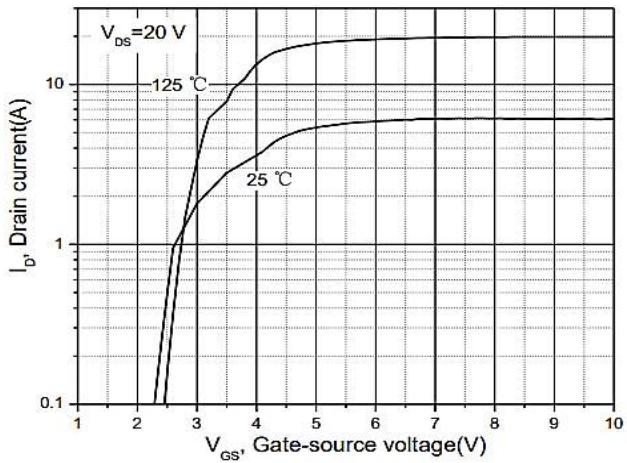


Figure 2. Typ. transfer characteristics

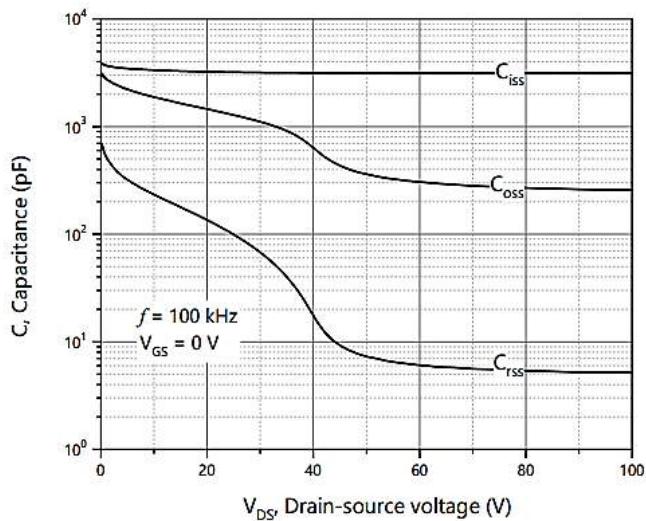


Figure 3. Typ. capacitances

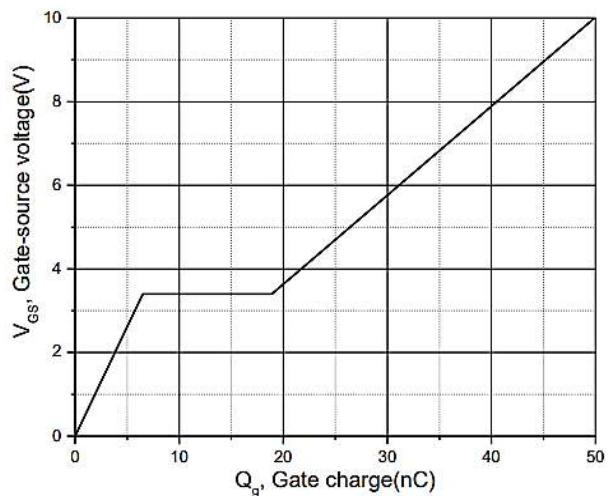


Figure 4. Typ. gate charge

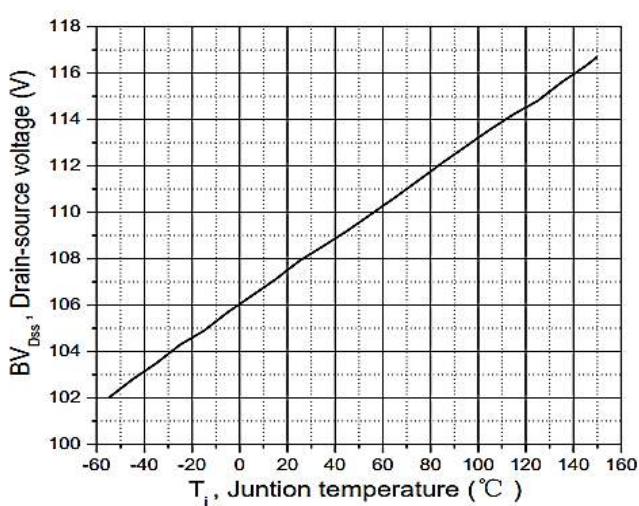


Figure 5. Drain-source breakdown voltage

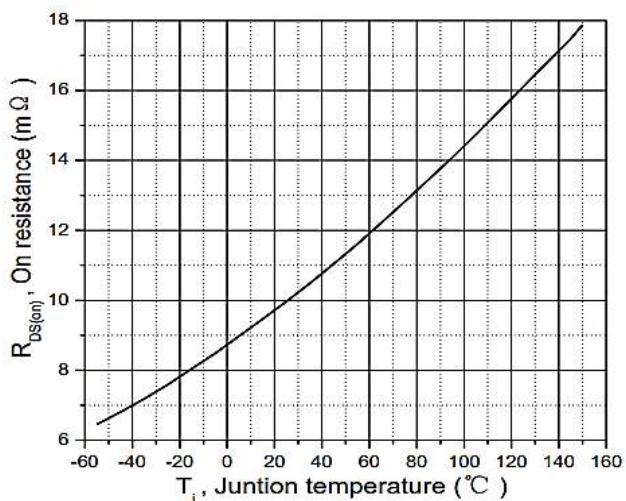
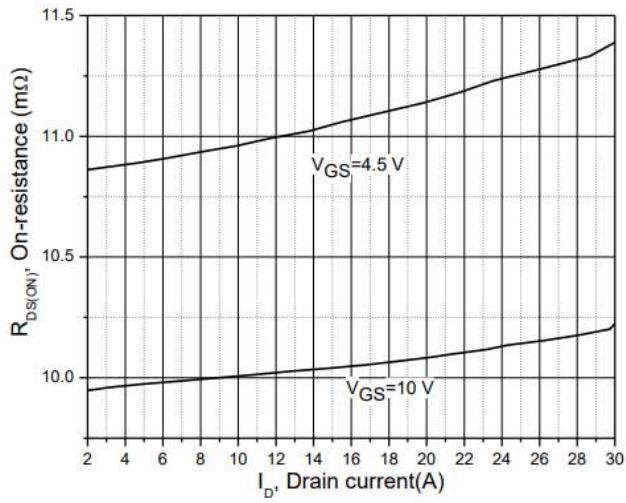
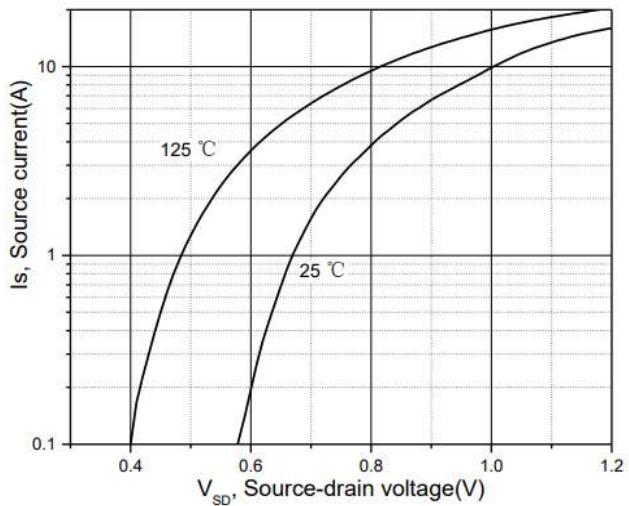
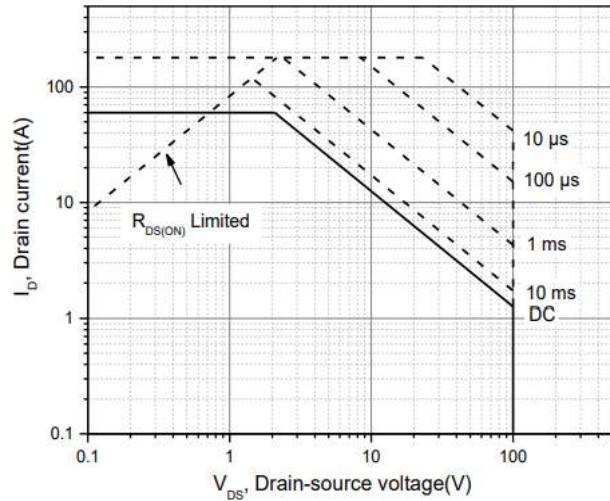
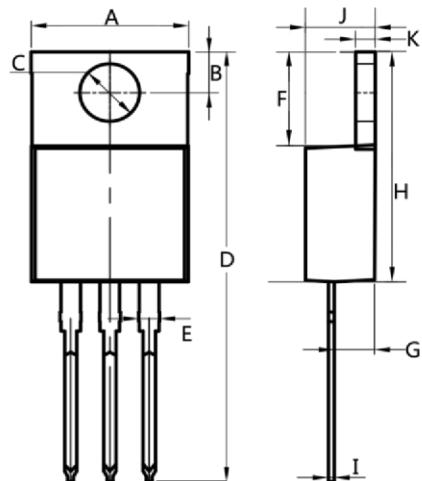


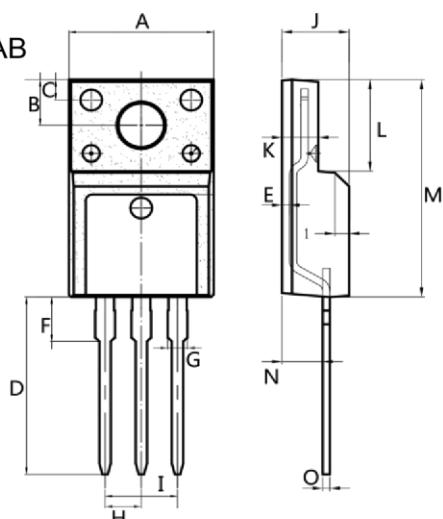
Figure 6. Drain-source on-state resistance

**100V N-Channel Enhancement Mode MOSFET**

**Figure 7. Drain-source on-state resistance**

**Figure 8. Forward characteristic of body diode**

**Figure 9. Safe operation area  $T_c=25\text{ }^\circ\text{C}$**

**TO-220AB**


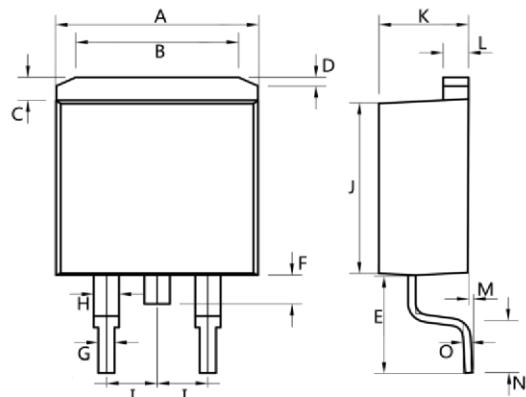
Dim.	Min.	Max.
A	10.0	10.4
B	2.5	3.0
C	3.5	4.0
D	28.0	30.0
E	1.1	1.5
F	6.2	6.6
G	2.9	3.3
H	15.0	16.0
I	0.35	0.45
J	4.3	4.7
K	1.2	1.4

All Dimensions in millimeter

**ITO-220AB**


Dim.	Min.	Max.
A	9.9	10.3
B	2.9	3.5
C	1.15	1.45
D	12.75	13.25
E	0.55	0.75
F	3.1	3.5
G	1.25	1.45
H	Typ 2.54	
I	Typ 5.08	
J	4.55	4.75
K	2.4	2.7
L	6.35	6.75
M	15.0	16.0
N	2.75	3.15
O	0.45	0.60

All Dimensions in millimeter

**TO-263**


Dim.	Min.	Max.
A	10.0	10.5
B	7.25	7.75
C	1.3	1.5
D	0.55	0.75
E	5.0	6.0
F	1.4	1.6
G	0.75	0.95
H	1.15	1.35
I	Typ 2.54	
J	8.4	8.6
K	4.4	4.6
L	1.25	1.45
M	0.02	0.1
N	2.4	2.8
O	0.35	0.45

All Dimensions in millimeter